

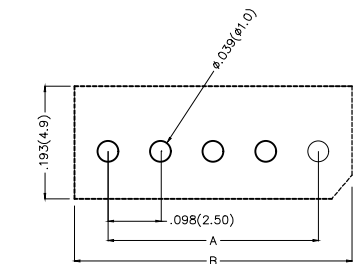
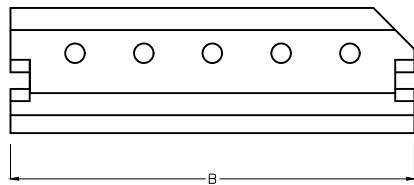
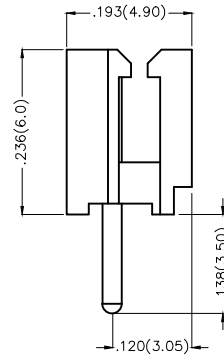
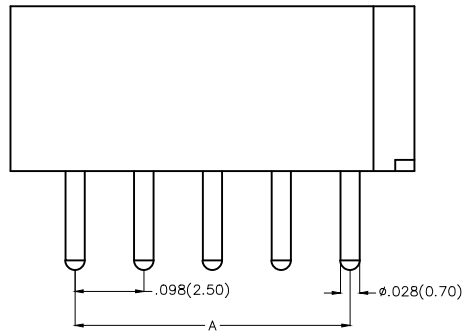
REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

Electrical

Current Rating: 3.0A AC(rms)/DC
Voltage Rating: 250V AC(rms)/DC
Contact Resistance: 20 mΩ Max
Insulation Resistance: 1000 MΩ MIN
Withstanding Voltage: 1000V AC r.m.s
Temperature Range—Operating: -25°C ~ +85°C

Material and Plating

Housing: PA66(UL 94V-2)
Contact Pin: Brass
Plating: Tin Plated



Recommended P.C.Board Layout

Ordering Information



FWF 250 03 - S XX S 2 2 W5 B
1 2 3 4 5 6 7 8 9 10

1 <u>Category</u> FWF—Wafer	2 <u>Series Number</u> 250—Pitch 2.5mm	3 <u>Distinction No.</u> 03	4 <u>Row Option</u> S—Single Row	5 <u>Circuits</u> XX	6 <u>Entry Angle</u> S—180° Vertical
7 <u>Plating</u> 2—Tin Plated	8 <u>Material—Resin</u> 2—PA66	9 <u>Color—Resin</u> W5—White	10 <u>Packaging</u> B—PE Bag		

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 01/JUL/13	PART NO. FWF25003-SXXS22W5B	ITEM NO. FWF25003	 Leader Of Industry	
	DESIGN UNITS Inch (metric)	X.±.012(0.30)	X.±5°	CHECKED BY JACOB	DATE 01/JUL/13	TITLE Wire to Board (Wafer) Pitch 2.5mm 180° Vertical (DIP)		REV 0
SCALE 5:1	SIZE A4	X.XX±.006(0.15)	.XX'±1°	DRAWN BY CHERRY	DATE 01/JUL/13	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF25003-S02S22W5B	.098(2.50)	.295(7.50)
3	FWF25003-S03S22W5B	.197(5.00)	.394(10.00)
4	FWF25003-S04S22W5B	.295(7.50)	.492(12.50)
5	FWF25003-S05S22W5B	.394(10.00)	.591(15.00)
6	FWF25003-S06S22W5B	.492(12.50)	.689(17.50)
7	FWF25003-S07S22W5B	.591(15.00)	.787(20.00)
8	FWF25003-S08S22W5B	.689(17.50)	.886(22.50)
9	FWF25003-S09S22W5B	.787(20.00)	.984(25.00)
10	FWF25003-S10S22W5B	.886(22.50)	1.083(27.50)
11	FWF25003-S11S22W5B	.984(25.00)	1.181(30.00)
12	FWF25003-S12S22W5B	1.083(27.50)	1.024(32.50)

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY	DATE	PART NO.	ITEM NO.	 Leader Of Industry
	X.±.012(0.30)	X.±5'	FRANK	01/JUL/13	FWF25003-SXXS22W5B	FWF25003	
DESIGN UNITS Inch (metric)	X.X±.008(0.20)	.X'±2'	CHECKED BY	DATE	TITLE		REV 0
SCALE	X.XX±.006(0.15)	.XX'±1'	JACOB	01/JUL/13	Wire to Board (Wafer) Pitch 2.5mm 180° Vertical (DIP)		
5:1	X.XXX±.004(0.10)	.XXX'±0.5'	DRAWN BY	DATE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
SIZE	A4		CHERRY	01/JUL/13			